

# Vishay Siliconix

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62				
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.0				

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•			•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		200	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	0.27	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		1.0	-	2.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 10		-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	25	μΑ
		V <sub>DS</sub> = 160 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	-	250	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 5.0 V	I <sub>D</sub> = 10 A <sup>b</sup>	-	-	0.18	Ω
Drain-Source On-State Resistance		$V_{GS} = 4.0 \text{ V}$	$I_D = 8.5 A^b$	-	-	0.27	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 10 A <sup>b</sup>		16	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V}, \\ V_{DS} = 25 \text{ V}$		-	1800	-	pF
Output Capacitance	C <sub>oss</sub>			-	400	-	
Reverse Transfer Capacitance	$C_{rss}$	f = 1.0	f = 1.0 MHz, see fig. 5		120	-	
Total Gate Charge	Qg			-	-	66	nC
Gate-Source Charge	$Q_{gs}$	$V_{GS} = 5.0 \text{ V}$	$I_{S} = 5.0 \text{ V}$ $I_{D} = 17 \text{ A}, V_{DS} = 160 \text{ V},$ see fig. 6 and 13 b		-	9.0	
Gate-Drain Charge	Q <sub>gd</sub>		occ lig. o and lo	-	-	38	1
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 100 V, $I_{D}$ = 17 A $R_{g}$ = 4.6 $\Omega$ , $R_{D}$ = 5.7 $\Omega$ , see fig. 10 $^{b}$		-	8.0	-	- ns
Rise Time	t <sub>r</sub>			-	83	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	44	-	
Fall Time	t <sub>f</sub>			-	52	-	
Internal Drain Inductance	$L_{D}$	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	- nH
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	
Gate Input Resistance	$R_g$	f = 1 MHz, open drain		0.3	-	1.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	17	- A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	68	
Body Diode Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 17  \text{A},  V_{GS} = 0  \text{V}^{ \text{b}}$		-		2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 17 A, dl/dt = 100 A/μs b		-	310	470	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	3.2	4.8	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )					

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

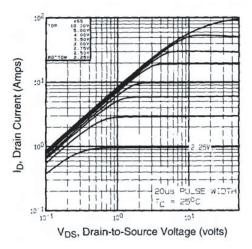


Fig. 1 - Typical Output Characteristics,  $T_C$  = 25  $^{\circ}C$ 

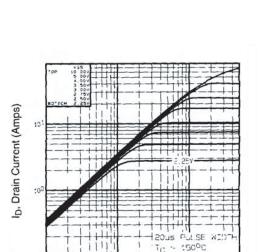


Fig. 2 - Typical Output Characteristics,  $T_C = 150$  °C

V<sub>DS</sub>, Drain-to-Source Voltage (volts)

:0"

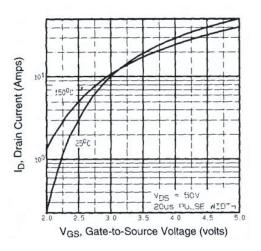


Fig. 3 - Typical Transfer Characteristics

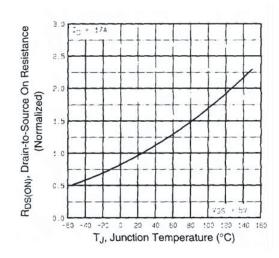


Fig. 4 - Normalized On-Resistance vs. Temperature



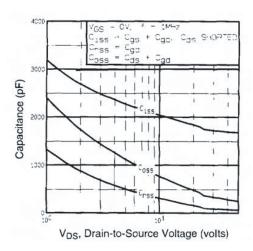


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

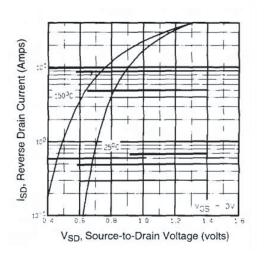


Fig. 7 - Typical Source-Drain Diode Forward Voltage

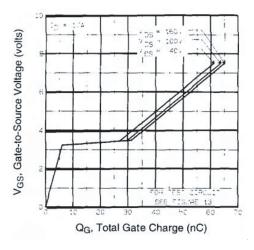


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

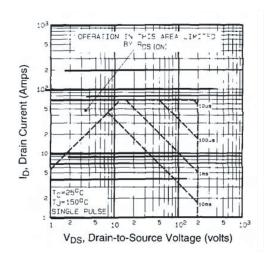


Fig. 8 - Maximum Safe Operating Area



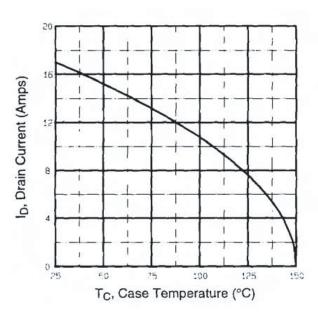


Fig. 9 - Maximum Drain Current vs. Case Temperature

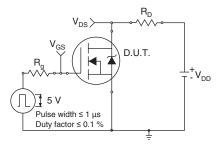


Fig. 10a - Switching Time Test Circuit

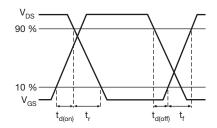


Fig. 10b - Switching Time Waveforms

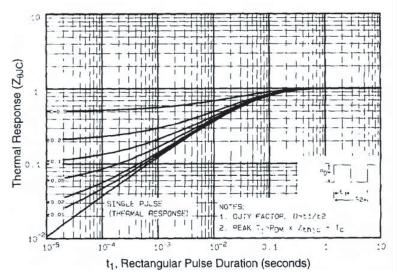


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

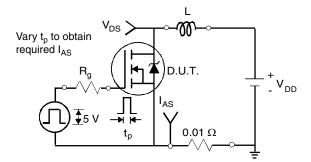


Fig. 12a - Unclamped Inductive Test Circuit

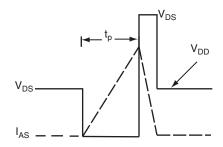


Fig. 12b - Unclamped Inductive Waveforms



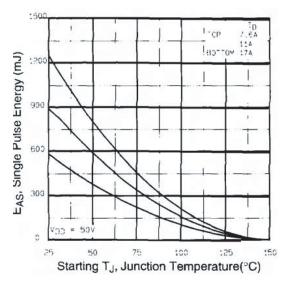


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

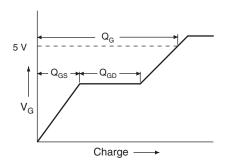


Fig. 13a - Basic Gate Charge Waveform

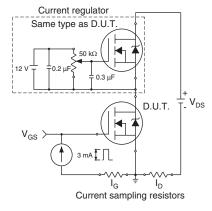
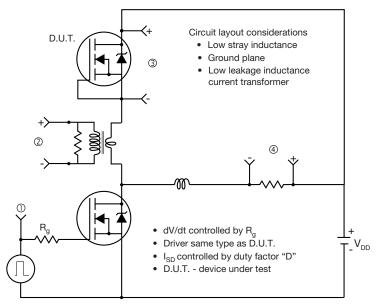


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



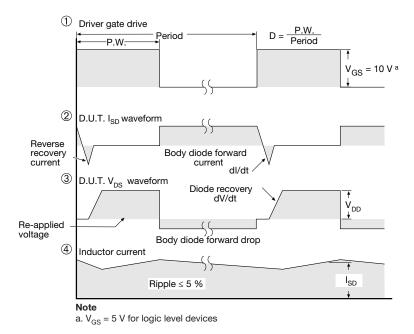


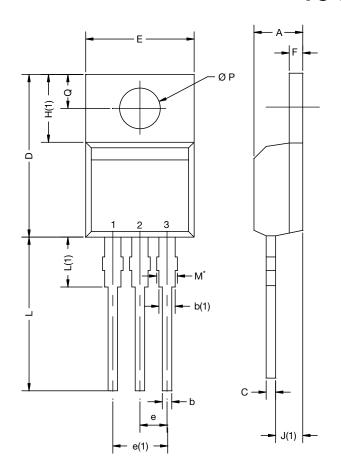
Fig. 14 - For N-Channel

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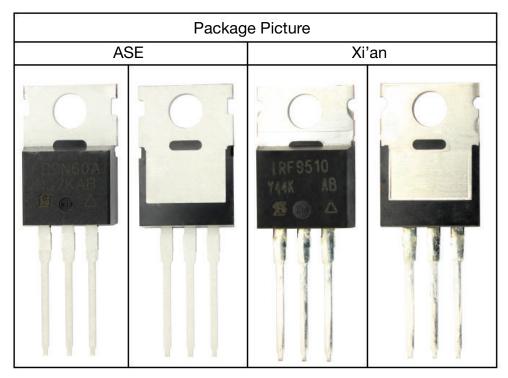
### TO-220-1



DIM.	MILLIM	IETERS	INCHES			
	MIN.	MAX.	MIN.	MAX.		
Α	4.24	4.65	0.167	0.183		
b	0.69	1.02	0.027	0.040		
b(1)	1.14	1.78	0.045	0.070		
С	0.36	0.61	0.014	0.024		
D	14.33	15.85	0.564	0.624		
Е	9.96	10.52	0.392	0.414		
е	2.41	2.67	0.095	0.105		
e(1)	4.88	5.28	0.192	0.208		
F	1.14	1.40	0.045	0.055		
H(1)	6.10	6.71	0.240	0.264		
J(1)	2.41	2.92	0.095	0.115		
L	13.36	14.40	0.526	0.567		
L(1)	3.33	4.04	0.131	0.159		
ØР	3.53	3.94	0.139	0.155		
Q	2.54	3.00	0.100	0.118		
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031						

#### Note

 $\bullet$   $\,$   $M^{\star}=0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542

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